

CALENDAR

Upcoming: February 6–10 AMN: Intl. Conf. on Advanced Materials and Nanotechnology, Endorsed; February 10–12 16th Annual General Meeting of MRS-India, MRS-I; March 28–April 1, 2005 MRS Spring Meeting, MRS.

To list an event in the Calendar, contact J. Meiksin, Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3004 ext. 522; fax 724-779-8313; bulletin@mrs.org.

MRS, A-MRS, B-MRS, C-MRS, E-MRS, MRS-A, MRS-I, MRS-J, MRS-K, MRS-R, MRS-S, MRS-T, M-MRS, or IUMRS at the end of an entry indicates sponsorship or co-sponsorship of an event by the International Union of Materials Research Societies or one of its adhering bodies. "Endorsed" identifies events endorsed by MRS.

▼ identifies a new or revised entry this month.

See the November 2004 MRS BULLETIN for January 2005 Calendar entries. For updates, access www.mrs.org/meetings/other/.

FEBRUARY 2005

5–8 ▼ ABRF—Biomolecular Technologies: Discovery to Hypothesis, *Savannah, GA*. Jean Lash, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings/abrf2005/.

6–11 AMN: Intl. Conf. on Advanced Materials and Nanotechnology, *Queenstown, New Zealand*. Conference Secretariat, Conference Office, Centre for Continuing Education, University of Canterbury, Private Bag 4800, Christchurch, New Zealand; 64-3-364-2534; fax 64-3-364-2324; e-mail amn2@cont.canterbury.ac.nz; www.elec.canterbury.ac.nz/AMN-2. Endorsed.

10–12 16th Annual General Meeting of MRS-India, *Pune, India*. Dr. K. Vijayamohan, Convenor, 16th AGM-MRSI Secretariat, Physical and Materials Chemistry Division, National Chemical Laboratory, Pune-411 008, INDIA; 91-020-25893300 ext.2002/2276; fax 91-020-25893044; e-mail mrsi2005@dalton.ncl.res.in; www.igcar.ernet.in/mrsi. MRS-I.

16–18 Smart Coatings 2005, *Orlando, FL*. Sandra Tanner, Coatings Research Institute, 430 W. Forest Ave., Ypsilanti, MI, 48197; 734-487-2203; fax 734-483-0085; e-mail sandy.tanner@emich.edu; www.emich.edu/public/coatings_research/smartcoatings/index2.html.

21–24 ▼ Intl. Display Manufacturing Conf. & Exhibition (IDMC), *Taipei, Taiwan*. 866-2-2504-4338x17; fax 866-2-2504-4362; e-mail idmc05@elitpeco.com.tw; www.dl.nctu.edu.tw/IDMC05.

MARCH 2005

6–9 Materials for Advanced Metallization 2005 (MAM2005), *Dresden, Germany*. MAM2005, 49-371-531-3130; e-mail info@mam-conference.org; www.mam-conference.org.

6–10 SPIE—Smart Structures and Materials & Nondestructive Evaluation for Health Monitoring and Diagnostics, *San Diego, CA*. SPIE, SPIE Meetings, P.O. Box 10, Bellingham, WA, 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org/events/ssnde.

8–9 RAPRA—High Performance Fillers 2005, *Cologne, Germany*. Rapra Technology Limited, Shawbury, Shrewsbury, SY4 4NR, United Kingdom; 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.polymerconferences.com.

14–18 ASNT Spring Conf. and 14th Annual Research Symp., *Albuquerque, NM*. Kelly Thomas, American Society for Nondestructive Testing, P.O. Box 28518, 1711 Arlington Ln, Columbus, OH 43228-0518, 800-222-2768 x227; fax 614-274-6899; kthomas@asnt.org; www.asnt.org.

15–16 RAPRA—Multimaterial Polymer Structures Conf., *Stuttgart, Germany*. Rapra Technology Limited, Shawbury, Shrewsbury, SY4 4NR, United Kingdom; 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.polymerconferences.com.

21–25 2005 American Physical Society March Meeting, *Los Angeles, CA*. Terri Gaier, APS, fax 301-209-0866; e-mail gaier@aps.org; www.aps.org/meet/MAR05.

28–1 MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. MRS.

APRIL 2005

1–2 Condensed Matter Workshop, *San Francisco, CA*. Materials Research Society, 506 Keystone Drive, Warrendale, PA, 15086; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org/meetings/workshops/2005/condensed_matter. MRS.

4–5 OPTO-Ireland 2005, *Dublin, Ireland*. SPIE, SPIE Meetings, P.O. Box 10, Bellingham, WA, 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org/conferences/calls/05/ire.

4–6 PM Asia—2005, *Shanghai, China*. Nick Williams, Inovar Event Management, Dogpole House, Shrewsbury, United Kingdom, 44-0-1743-241289; e-mail Nick@inovar-events.com; www.pmasia2005.com.

4–7 ▼ Government Microcircuit Applications & Critical Technology Conf. (GOMACTech), *Las Vegas, NV*. Kate Dickie, GOMACTech, 212-460-8090 x215; e-mail kdickie@pcm411.com; www.gomactech.net.

4–8 2005 Intl. Magnetism Conf. (INTERMAG2005), *Nagoya, Japan*. Intermag 2005 Secretariat, c/o Convention Linkage, Inc., Akasaka-Nihon Bldg., 9-5-24, Akasaka, Minato-ku, Tokyo 107-0052, Japan; 81-3-5770-5531; fax 81-3-5770-5532; e-mail info@intermag2005.jp; www.intermag2005.jp. Endorsed.

11–13 The Intl. Conf. on Ceramic Interconnect and Ceramic Microsystems Technology, *Westerville, OH*. Ann Bell, IMAPS, 202-548-8717; e-mail abell@imaps.org; www.ceramics.org.

11–14 Fourteenth Intl. Conf. on Microscopy of Semiconducting Materials, *Oxford, United Kingdom*. Univ. of Sheffield, Tony Cullis, Sheffield, United Kingdom, 44-114-222-5407; fax 44-114-272-6391; e-mail a.g.cullis@sheffield.ac.uk; www.rms.org.uk. Endorsed.

24–28 15th Intl. Conf. on Wear of Materials, *San Diego, CA*. Gill Heaton, Secretariat, Hillside Cottages, Wheatley Road, Islip, Oxford OX5 2TF, UK; 44-0-1865-373625; fax 44-0-1865-375855; e-mail wom-conference@elsevier.com; www.wom-conference.elsevier.com.

MAY 2005

8–10 Meeting of Society of Nano Science and Technology, *Sendai, Japan*. Yukiko Miyahara, Tohoku University, 2-1-1 Katahira Aoba-ku, Sendai, Japan, 81-22-215-2054; fax 81-22-215-2052; e-mail nano2005@imr.edu; www.nano2005.imr.edu/english_index.html.

10–11 RAPRA—Blowing Agents & Foaming Processes 2005, *Stuttgart, Germany*. Rapra Technology Limited, Shawbury, Shrewsbury, SY4 4NR, United Kingdom, 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.polymerconferences.com.

29–3 2nd Intl. Conf. on Electrophoretic Deposition: Fundamentals and Applications, *Barga, Italy*. Impe. C. of Sci. Tech. & Med., A Boccacini, London, United Kingdom, 44-207-5946731; fax 44-207-5843194; e-mail a.boccacini@imperial.ac.uk; www.engconfintl.org/5ad.html.

29–3 Solid-Solid Phase Transformations in Inorganic Materials 2005, *Phoenix, Arizona*. TMS Meeting Services, 184 Thorn Hill Road, Warrendale, PA 15086 USA; 724-776-9000, ext. 243; e-mail mtgserv@tms.org; www.tms.org/meetings/specialty/ptm/home.html. Endorsed.

31–3 2005 E-MRS Spring Meeting, *Strasbourg, France*. Paul Siffert, General Secretary, European Materials Research Society Headquarters, BP 20, 67037 Strasbourg Cedex 2, France; 33-3-88-106273; fax 33-3-88-106343; e-mail emrs@phase.c-strasbourg.fr; www.emrs.c-strasbourg.fr. E-MRS.

JUNE 2005

7–10 ▼ Intl. Conf. on Advances in Solidification Processes (ASP), *Stockholm, Sweden*. KTH Casting of Metals, ASP, S-100 44, Stockholm, Sweden, 46-8-790-6654; fax 46-8-21-65-57; e-mail asp@matpr.kth.se; www.webforum.com/solidificationprocessing. E-MRS.

9–11 ▼ China Intl. Conf. on Nanoscience and Technology (ChinaNano2005), *Beijing, Peoples Republic of China*. e-mail chinanano@nanocn.cn; www.chinanano2005.org.

20–22 ▼ ISPAC: Intl. Symp. on Polymer Analysis and Characterization, *Sheffield, United Kingdom*. University of Sheffield, Shelagh Cowley, Dainton Building, Brook Hill, Sheffield, United Kingdom, 44(0)114-222-9537; fax 44(0)114-222-9389; e-mail s.h.cowley@sheffield.ac.uk; www.chem.cmu.edu/ispac.

26–30 17th University Conf. on Glass Science, *University Park, PA*. Carlo Pantano; www.mri.psu.edu/conferences/glassscience.

JULY 2005

3–8 Intl. Conf. on Materials for Advanced Technologies (ICMAT 2005) and IUMRS-ICAM 2005, *Singapore*. Mat Research Soc (Singapore), ICMAT Secretariat, 3 Research Link, Singapore, 65-6874-1975; fax 65-6777-2393; e-mail icmat@mrs.org.sg; www.mrs.org.sg/meeting_future.html. IUMRS/MRS-S.

4–8 Lucerne Fuel Cell Forum 2005, *Lucerne, Switzerland*. EFCE, Morgenacherstrasse 2F, P.O. Box 99, Oberrohrdorf, Switzerland, 41-56-496-7292; fax 41-56-496-441; e-mail forum@efce.com.

6–8 ▼ Intl. Conf. on Diffusion in Solids and Liquids (DSL-2005), *Aveiro, Portugal*. University of Aveiro, Dept. of Mechanical Engineering, Campus Universitario de Santiago, Aveiro, Portugal, 351-234-378162; fax 351-234-370953; e-mail DSL-2005@mec.ua.pt; www.event.ua.pt/dsl2005.

10–13 Organic Microelectronics Workshop, *Newport, RI*. 202-872-4600 or 1-800-227-5558; e-mail acsprospectives@acs.org; www.mrs.org/meetings/workshops/2005/organic_microelectronics. MRS.

10–15 16th Intl. Conf. on Electronic Properties of Two-Dimensional Systems (EP2DS-16), *Albuquerque, NM*. Jerry Simmons, 505-844-8402; e-mail jsimmon@sandia.gov. Endorsed.

17–22 Intl. Conf. on Solid State Ionics (SSI-15), *Baden-Baden, Germany*. Ellen Ivers-Tiffée, c/o Universität Karlsruhe, Kaiserstr. 12, D-76131 Karlsruhe, Germany; 49-721-608-7491; fax 49-721-608-7492; e-mail info@ssi-15.net; www.ssi-15.net.

19–23 5th Intl. Conf. on Intelligent Processing and Manufacturing of Materials, *Monterey, CA*. IPMM 05, www.mining.ubc.ca/ipmm.

AUGUST 2005

28–2 6th Intl. Conf. on Nitride Semiconductors (ICNS-6), *Bremen, Germany*. Sven Einfeldt, University of Bremen, P.O. Box 330440, Bremen, Germany; 49-421-218-7453; fax 49-421-218-4581; e-mail icns6@ifp.uni-bremen.de; www.ifp.uni-bremen.de/brens6.

30-2 ECSSC X 2005 European Conf. on Solid State Chemistry, *Sheffield, United Kingdom*. Louise Draycott, University of Sheffield, Sir Robert Hadfield Building, Mappin Street, Sheffield, United Kingdom, 44-0-114-222-60-27; fax 44-0-114-222-59-43; e-mail L.Draycott@sheffield.ac.uk; www.shef.ac.uk/materials/ecssc.

SEPTEMBER 2005

12-16 ▼ European Solid-State Device Research Conf. (ESSDERC), *Grenoble, France*. Iris Mazure, 46 Avenue Felix Viallet, Grenoble Cedex, France, 33-476-57-49-89; fax 33-476-47-38-14; e-mail esscirc-essderc@imag.fr; www.essderc2005.com.

OCTOBER 2005

2-5 3rd Fracture and Flow in Advanced Glasses Conf., *University Park, PA*. Carlo Pantano; ars2@psu.edu.

9-14 ▼ ECI—Instrumented Indentation Testing in Materials Research and Development, *Crete, Greece*. E-mail info@eci.poly.edu; www.engconfintl.org/5av.html.

17-21 ASNT Fall Conf. and Quality Testing Show 2005, *Columbus, OH*. Kelly Thomas, American Society for Nondestructive Testing, P.O. Box 28518, 1711 Arlingate Ln, Columbus, OH 43228-0518; 800-222-2768 x227; fax 614-274-6899; kthomas@asnt.org; www.asnt.org.

NOVEMBER 2005

14-16 Continuous Casting of Non-Ferrous Metals Intl. Conf. & Exhibition, *Neu-Ulm, Germany*. Vera Hausen, Niels Parusel, DGM Secretariat, Deutsche Gesellschaft für Materialkunde, Hamburger Allee 26, Frankfurt, Germany, 49-69-7917-747; fax 49-69-7917-733; e-mail concast@dgm.de; www.dgm.de/concast.

22-25 Ninth NCB Intl. Seminar on Cement, *New Delhi, India*. NCCBM, Ninth NCB, 34 Km Stone, Delhi Mathura Road (NH2), Ballabgarh 121 004, Haryana, India, 91-129-2242051-56; fax 91-129-2242100, 2246175; e-mail nccbm@giast101.vsnl.net.in.

29-3 **MRS Fall Meeting**, *Boston, MA*. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org.

DECEMBER 2005

4-9 ▼ Intl. Conf. on Fusion Reactor Materials, *Santa Barbara, CA*. R.J. Kurtz, e-mail icfrm-tp@engineering.ucsb.edu; www.icfrm-12.pnl.gov/index.stm.

5-7 2nd Intl. Conf. on Advances in Production and Processing of Aluminum (APPA 2005), *Bahrain*. Conf. Secretariat (APPA 2005), Univ. of Bahrain, P.O. Box 32038, Bahrain, 973-17876114; fax 973-17876655; e-mail appa2005@eng.uob.bh; www.uob.edu.bh/colleges/engineering/conf/index.htm.

AUGUST 2006

27-31 ▼ **TMS—Sohn Intl. Symp. on Advanced Materials: Principles, Technologies, and Industrial Practice**, *San Diego, CA*. TMS Meetings Services, 184 Thorn Hill Road, Warrendale, PA, 15086; 724-776-9000 x243; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org/Meetings/Specialty/FallExt2006/FallExt2006-Home.html. **Endorsed.** □